



SDM2U20CSP

2.0A SCHOTTKY BARRIER RECTIFER CHIP SCALE PACKAGE

### **Product Summary**

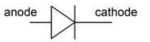
V <sub>RRM</sub> (V)	I <sub>O</sub> (A)	V <sub>F</sub> Max (V)	I <sub>R</sub> Max (μA)
20	2.0	0.47	150

### Description

The SDM2U20CSP is a 20-volt 2A Schottky Barrier Rectifier that is optimized for low forward voltage drop and low leakage current, housed in a compact chip scale package (CSP) that occupies only 1.28mm<sup>2</sup> board-space with low profile. The low thermal resistance enables designers to meet design challenges of increasing efficiency while at the same time reducing board space.

# Applications

- Blocking Diode
- Boost Diode
- Switching Diode
- Reverse Protection Diode



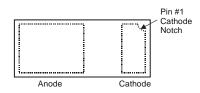
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# Features and Benefits

- Low Forward Voltage (V<sub>F</sub>) Minimizes Conduction Losses and Improving Efficiency
- Reduced High Temperature Reverse Leakage
- Increased Reliability Against Thermal Runaway Failure in High Temperature Operation
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

- Case: X3-WLB1608-2
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiAu Bump. Solderable per MIL-STD-202, Method 208 @
- Polarity: Cathode Dot
- Weight: 0.001 grams (Approximate)



#### Ordering Information (Note 4)

Part Number	Case	Packaging
SDM2U20CSP-7B	X3-WLB1608-2	10,000/Tape & Reel
SDM2U20CSP-7	X3-WLB1608-2	5,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.htmlfor more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html. SDM2U20CSP-7B uses carrier tapes with 2mm pocket-to-pocket pitch; SDM2U20CSP-7 uses carrier tapes with 4mm pocket-to-pocket pitch.

# **Marking Information**



X3= Product Type Marking Code YM=Date Code Marking Y= Year (ex: B= 2014) M=Month (ex: 9= September) Dot denotes Cathode Pin

Date Code Key

Year	201	4	2015		2016	20	17	2018		2019	2	2020
Code	В		С		D	E		F		G		Н
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	20	V
Average Rectified Output Current	lo	2.0	A
Repetitive Peak Forward Current (Pulse Wave = 1 sec, Duty Cycle = 66%)	IFRM	5.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	IFSM	20	A

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	R <sub>θJA</sub>	150	°C/W
Total Power Dissipation (Note 5)	P <sub>TOT</sub>	830	mW
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

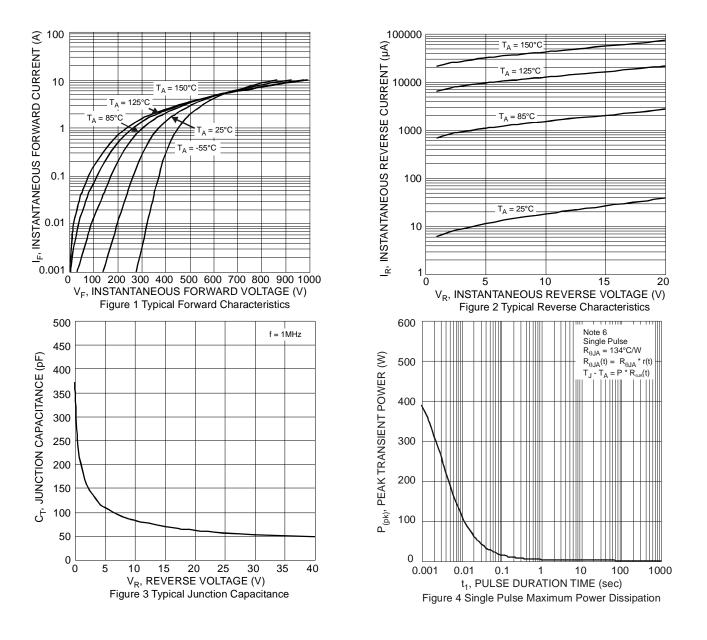
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Valtage Drop	V <sub>F</sub>			0.42	V	I <sub>F</sub> = 1.0A
Forward Voltage Drop		_	_	0.47	v	I <sub>F</sub> = 2.0A
Reverse Current (Note 7)	I <sub>R</sub>	_	40	150	μA	V <sub>R</sub> = 20V
Junction Capacitance	CJ		115		pF	$V_{R} = 4V, f = 1.0MHz$

 Device mounted on FR-4 PCB, 2oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.
Device mounted on FR-4 PCB, 2oz. Copper, 1 square inch pad.
Short duration pulse test used to minimize self-heating effect. Notes:

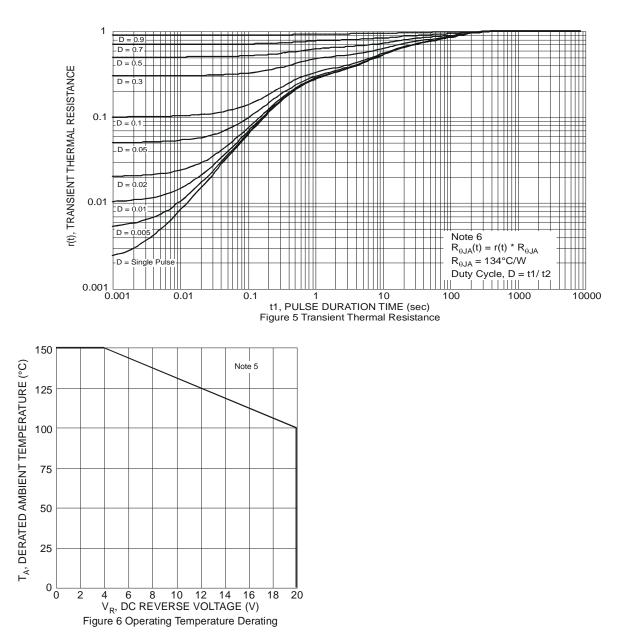


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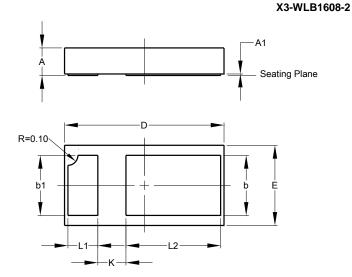






# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

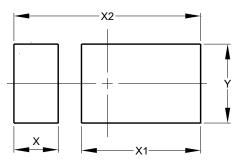


	X3-WLB1608-2					
Dim	Min	Max	Тур			
Α	0.250	0.300	0.275			
A1	-	0.015	-			
b	_	_	0.600			
b1	-	-	0.600			
D	1.57	1.63	1.60			
Е	0.77	0.83	0.80			
Κ	-	-	0.282			
L1	0.25	0.35	0.30			
L2	0.90	1.00	0.95			
All I	Dimens	ions in	mm			

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.





Dimensions	Value (in mm)
Х	0.385
X1	1.035
X2	1.622
Y	0.690

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